

Features

- Select models are compliant with AEC-Q200 Rev-C Stress Test Qualification for Passive Components in Automotive Applications (see chart below)
- RoHS compliant*
- ESD protection >25 kV
- Low capacitance <0.5 pF
- Low leakage current <50 nA

ChipGuard® MLC Series - ESD Protectors

General Information

The ChipGuard® MLC Series has been specifically designed to protect sensitive electronic components from electrostatic discharge damage. The MLC family has been designed to protect equipment to IEC61000-4-2, Level 4 (±8 kV Contact / ±15 kV Air Discharge) ESD specifications targeted for high speed USB 3.0/USB OTG, HDMI 1.4, DVI or IEEE1394 applications.

The ChipGuard[®] MLC Series has been manufactured to provide low 0.5 pF capacitance and leakage currents less than 50 nA with excellent clamp qualities, making the family almost transparent under normal working conditions.

AEC Approved Models

Digital Visual Interface (DVI)

Applications

■ USB 3.0 / USB OTG

Memory protection

SIM card ports

Automotive

HDMI 1.4

Model	AEC-Q200
CG0603MLC-05E	✓ Yes
CG0603MLC-12E	✓ Yes

Device Symbol



Electrical Characteristics @ 25 °C (unless otherwise noted)

Devenue atex	Querrahaal	CG0402MLC-								
Parameter	Symbol	3.3LG	05LG	12LG	24LG	3.3LGA	05LGA	12LGA	24LGA	Unit
Typical Continuous Operating Voltage	V _{DC}	3.3	5	12	24	3.3	5	12	24	V
Typical Clamping Voltage (Note 1)	VC				2	25				V
Maximum Capacitance @ 1 VRMS 1 MHz	CO				C).5				pF
Maximum Leakage Current @ Max. VDC	١L				:	5				nA
Typical Trigger Voltage (Note 2)	VT		250					V		
Maximum Response Time	RT		1				ns			
ESD Protection: Per IEC 61000-4-2 Level 4 Min. Contact Discharge Min. Air Discharge Min. Air Discharge			±8 ±15 (Note 3) ±25					kV kV kV		
Operating Temperature	TOPR	-40 to +85 -40 to +125					°C			
Storage Temperature	TSTG	-55 to +150				°C				

Devementer	Cumhal	CG0603MLC-								Unit		
Parameter	Symbol	3.3LE	05E	05LE	12E	12LE	24LE	3.3LEA	05LEA	12LEA	24LEA	Unit
Typical Continuous Operating Voltage	V _{DC}	3.3	5	5	12	12	24	3.3	5	12	24	V
Typical Clamping Voltage (Note 1)	VC	25	20	25	25 30 25							V
Maximum Capacitance @ 1 VRMS 1 MHz	CO					0	.5					pF
Maximum Leakage Current @ Max. VDC	١L	5	50	5	50	5						nA
Typical Trigger Voltage (Note 2) VT		250	150	250	150	250						V
Maximum Response Time	RT	1					ns					
ESD Protection: Per IEC 61000-4-2 Level 4 Min. Contact Discharge Min. Air Discharge Min. Air Discharge		±8 ±15 (Note 3) ±25					kV kV kV					
Operating Temperature	TOPR	-40 to +85 -40 to +125				°C						
Storage Temperature	TSTG	-55 to +150			°C							

Notes: 1. Per IEC 61000-4-2, Level 4 8 kV Contact Discharge. Measurement 30 ns after initiation of pulse.

2. Per IEC 61000-4-2, Level 4 8 kV Contact Discharge. Measurement at maximum pulse voltage.

3. IEC 61000-4-2 ESD Performance for CG0603MLC-05E and CG0603MLC-12E devices will meet minimum 100 reps. Some shifting in characteristics may occur when tested over several hundred ESD pulses. All other part numbers listed will meet IEC 61000-4-2 ESD Performance with minimum 1000 reps without degradation in performance.

*RoHS Directive 2002/95/EC Jan. 27, 2003 including annex and RoHS Recast 2011/65/EU June 8, 2011. Specifications are subject to change without notice.

The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time. Users should verify actual device performance in their specific applications.

ChipGuard[®] MLC Series - ESD Protectors

CG0402

Series

 0.25 ± 0.15

 (0.10 ± 0.006)

Bourns

Recommended Pad Layout

Product Dimensions

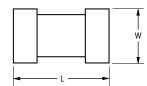
Dimension

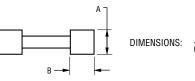
L

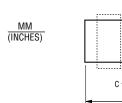
W

А

В







4	• U	
Dim.	CG0402 Series	CG0603 Series
А	<u>0.51</u> (0.020)	<u>0.76</u> (0.030)
В	<u>0.61</u> (0.024)	<u>1.02</u> (0.040)
С	<u>0.51</u> (0.020)	<u>0.50</u> (0.020)

1.70

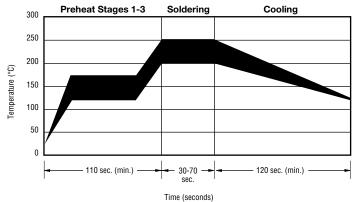
(0.067)

В

2.54

(0.100)

Solder Reflow Recommendations



_				
	A	Stage 1 Preheat	Ambient to Preheating Temperature	30 s to 60 s
	В	Stage 2 Preheat	140 °C to 160 °C	60 s to 120 s
	С	Stage 3 Preheat	Preheat to 200 °C	20 s to 40 s
	D	Main Heating	200 °C 210 °C 220 °C 230 °C 240 °C 250 °C to 255 °C	60 s to 70 s 55 s to 65 s 50 s to 60 s 40 s to 50 s 30 s to 40 s 5 s
	E	Cooling	200 °C to 100 °C	1 °C/s to 4 °C/s

D

Title (Secolius)

This product can be damaged by rapid heating, cooling or localized heating.

· Heat shocks should be avoided. Preheating and gradual cooling recommended.

Excessive solder can damage the device. Print solder thickness of 150 to 200 um recommended.

 Solder gun tip temperature should be kept below 280 °C and should not touch the device directly. Contact should be less than 3 seconds. A solder gun under 30 watts is recommended.

 $\begin{array}{c|c} \hline 1.00 \pm 0.15 \\ \hline (0.04 \pm 0.006) \\ \hline \hline 0.50 \pm 0.10 \\ \hline (0.02 \pm 0.004) \\ \hline \hline 0.36 \pm 0.05 \\ \hline (0.014 \pm 0.002) \\ \hline \hline \end{array} \begin{array}{c|c} \hline 1.60 \pm 0.20 \\ \hline (0.064 \pm 0.008) \\ \hline \hline (0.032 \pm 0.008) \\ \hline \hline 0.45 \pm 0.10 \\ \hline (0.018 \pm 0.004) \\ \hline \end{array} \begin{array}{c|c} A \\ \hline \hline 0.51 \\ \hline (0.020) \\ \hline B \\ \hline \hline 0.61 \\ \hline (0.024) \\ \hline \hline (0.024) \\ \hline \hline (0.020) \\ \hline \end{array}$

CG0603

Series

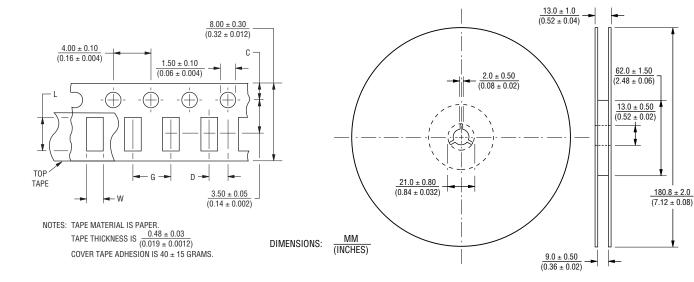
 0.30 ± 0.20

 (0.012 ± 0.008)

ChipGuard[®] MLC Series - ESD Protectors

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Packaging Dimensions



Dimension	CG0402 Series	CG0603 Series
С	$\frac{1.75 \pm 0.05}{(0.04 \pm 0.002)}$	$\frac{1.75 \pm 0.10}{(0.04 \pm 0.004)}$
D	$\frac{2.00 \pm 0.02}{(0.08 \pm 0.0008)}$	$\frac{2.00 \pm 0.05}{(0.08 \pm 0.002)}$
L	$\frac{1.12 \pm 0.03}{(0.045 \pm 0.0012)}$	$\frac{1.80 \pm 0.20}{(0.072 \pm 0.008)}$
W	$\frac{0.62 \pm 0.03}{(0.025 \pm 0.0012)}$	$\frac{0.90 \pm 0.20}{(0.036 \pm 0.008)}$
G	$\frac{2.0 \pm 0.05}{(0.08 \pm 0.002)}$	$\frac{4.0 \pm 0.05}{(0.16 \pm 0.002)}$

How to Order
CG 0n0n MLC - n.n x x x
ChipGuard® Product Designator Package Option 0402 = 0402 Package 0603 = 0603 Package
Multilayer Series Designator —
Operating Voltage** 3.3 = 3.3 V 05 = 5 V 12 = 12 V 24 = 24 V
Low Leakage Current Option L = Low Leakage Current Blank = Standard Product
Tape & Reel Packaging E = 5,000 pcs. per reel (0603 Package) G = 10,000 pcs. per reel (0402 Package)
Operating Temperature Option

A = Higher +125 °C Operating Temperature Blank = Standard Product

** Only models lower than 10 volts require decimal point.

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REV. S 06/13

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